Document Number: I2MEH0145-1 Production Datasheet V1.0

0.1-4.5GHz, 1W, 28V LDMOS 2-stage Fully matched PA Module

Description

The I2MEH0145-1 is a 1-watt,2-stage integrated Power Amplifier Module, designed for broadband applications, with frequencies from 0.1 to 4.5GHz by simple external connection between 2 stages. The module is 50 Ω input/output matched and requires minimal external components.



The module implements distributed power amplifier in form of multi chips, housed in cost effective plastic open cavity package, offers a much lower cost than traditional MMIC solutions.

Typical CW RF performance with device soldered on PCB with high density grounding vias

V_{DS}= 28V, I_{DQ}=40 mA, Vgs =2.80V

Parameter	100MHz	0.5GHz	1.0GHz	1.5GHz	2.0GHz	2.5GHz	3.0GHz	4.0GHz	4.5GHz	Units
Linear Gain	19.4	17.4	17.0	16.4	17. 9	18.0	18.4	18. 3	16.7	dB
Pout@Pin=15dBm	1.7	1.5	1.4	1.1	1.3	1.3	1.3	1.4	1.2	W
Gain@Pin=15dBm	17. 1	16.8	16. 3	15.6	16. 2	16. 1	16.0	16.6	16.0	dB
Eff@ Pin=15dBm	21	19	17	15	18	18	17	21	21	%

Product Features

• Operating Frequency Range: 0.1-4.5GHz

• Operating Drain Voltage: +28 V

50 Ω Input/OutputPsat: ≥1W(CW)

Small signal gain:>16dB

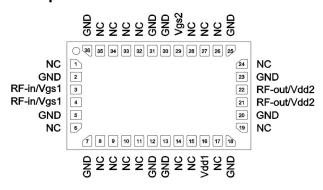
• Minimum efficiency:>15%

- 6x10 mm Surface Mount Package
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC
- Much lower cost than GaN-based ultrawide band PA, due to LDMOS technology used

Applications

- Ultra Broadband Amplifiers
- Fiber Drivers
- Test Instrumentation
- EMC Amplifier Drivers
- 2-way Radios

Pin Configuration and Description



Pin No. Symbol Description



Document Number: I2MEH0145-1 Production Datasheet V1.0

21,22	RFout/Vdd2	Transistor 1, Drain Bias2 & RF Output
3,4	RFin/Vgs1	Transistor 1, Gate Bias1 & RF Input
29	Vgs2	Transistor 1, Gate Bias2
16	Vdd1	Transistor 1, Drain Bias1
Others	NC	No connection
		DC/RF Ground. Must be soldered to EVB ground plane over array of
2,5,7,12, 13,18,20,23,25, 30, 31,36 Package Base	GND	vias for thermal and RF performance. Solder voids under Pkg Base will result in excessive junction temperatures causing permanent damage.

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	65	Vdc
GateSource Voltage	V_{GS}	-10 to +10	Vdc
Operating Voltage	V_{DD}	+32	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	T₃	+200	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Do 10	14	°C/M
T _C = 87°C, T _J =175°C, DC test	Rejc	14	°C/W

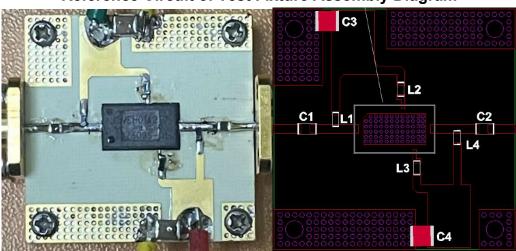
Table 3. Electrical Characteristics

Parameter	Condition	Min	Тур	Max	Unit
Frequency Range		30		4000	MHz
Power Gain @ Psat			21		dB
P _{SAT}		30			dBm
Drain Efficiency @ P _{SAT}		15			%
Unless otherwise noted: TA = 25°C, V _{DD} =28 V, Pulse Width=100 us, Duty cycle=10%					

Load Mismatch of per Section (On Test Fixture, 50 ohm system): $V_{DD} = 28 \text{ V}$, $I_{DQ} = 100 \text{ mA}$, f = 3 GHz

VSWR 10:1 at Psat pulse CW Output Power No Device Degradation

Reference Circuit of Test Fixture Assembly Diagram

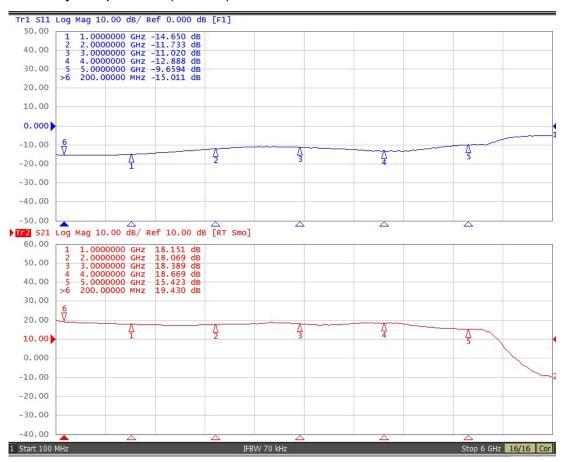


Document Number: I2MEH0145-1 Production Datasheet V1.0

		Part NO.	Vendor
C1, C2	50V 1uF Chip Capacitor	GRM21BR71H105KA12L	muRata
C3,C4	10uF 100V Chip Capacitor	C5750X7S2A106M230KB	TDK
L1, L2,L3,L4	470 nH Capacitor(0603)	LQW18CNR47J00D	muRata
РСВ	RO4350B,20mil,er=3.48		

TYPICAL CHARACTERISTICS

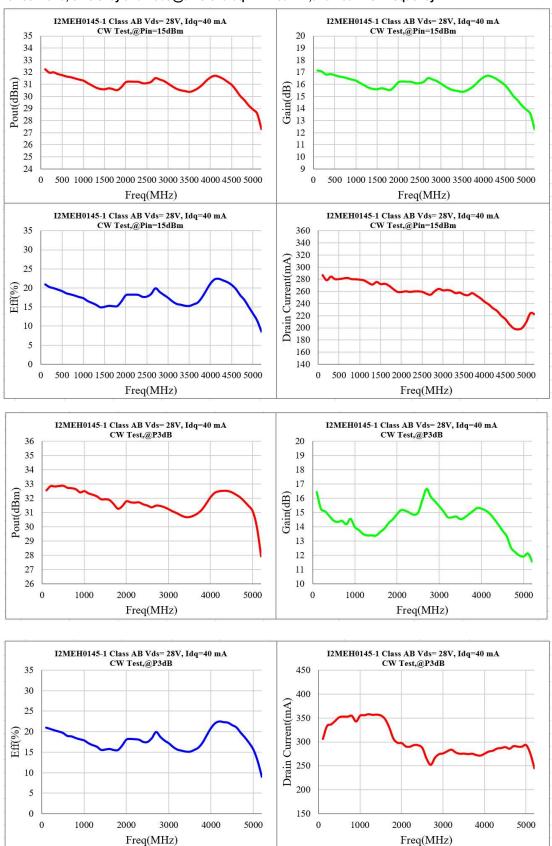
Figure 1. Network analyzer output S11/S21 (Pin=0dBm)





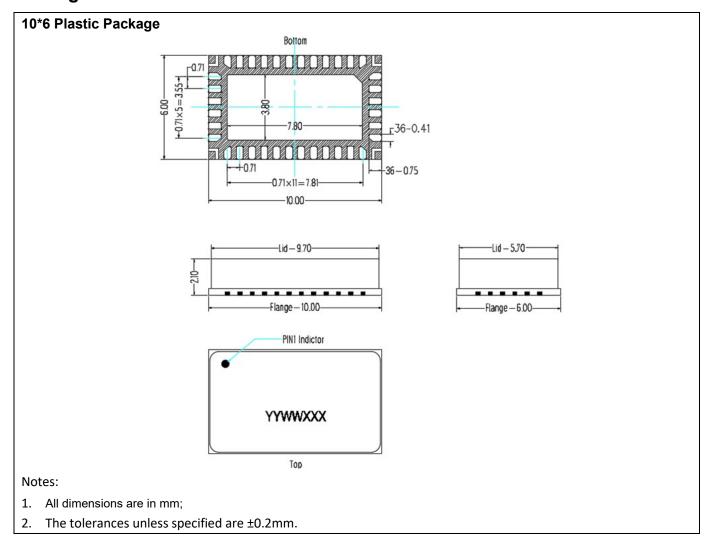
Document Number: I2MEH0145-1 Production Datasheet V1.0

Figure. Power Gain and, efficiency and Pout @different Idq/Pin=15dBm ,and P3dB vs. Frequency

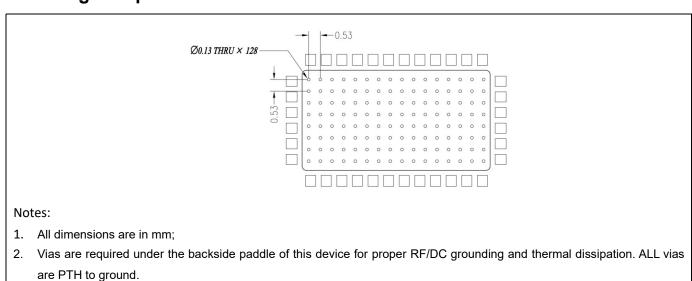


Document Number: I2MEH0145-1 Production Datasheet V1.0

Package Dimensions



Mounting Footprint Pattern



Document Number: I2MEH0145-1 Production Datasheet V1.0

Revision history

Table 6. Document revision history

Date	Revision	Datasheet Status
2023/6/8	Rev 1.0	Production Datasheet

Application data based on ZHH-23-09

Disclaimers

Specifications are subject to change without notice. Innogration believes the information contained within this data sheet to be accurate and reliable. However, no responsibility is assumed by Innogration for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Innogration . Innogration makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose. "Typical" parameters are the average values expected by Innogration in large quantities and are provided for information purposes only. These values can and do vary in different applications and actual performance can vary over time. All operating parameters should be validated by customer's technical experts for each application. Innogration products are not designed, intended or authorized for use as components in applications intended for surgical implant into the body or to support or sustain life, in applications in which the failure of the Innogration product could result in personal injury or death or in applications for planning, construction, maintenance or direct operation of a nuclear facility. For any concerns or questions related to terms or conditions, pls check with Innogration and authorized distributors Copyright © by Innogration (Suzhou) Co.,Ltd.